# Ignition IGBT 12 A, 410 V N-Channel DPAK

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over-Voltage clamped protection for use in inductive coil drivers applications. Primary uses include motorbike ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

#### **Features**

- Ideal for Coil-on-Plug Applications
- DPAK Package Offers Smaller Footprint and Increased Board Space
- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Low Saturation Voltage
- High Pulsed Current Capability
- These are Pb-Free Devices

## MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CES</sub>	445	$V_{DC}$
Collector-Gate Voltage	V <sub>CER</sub>	445	$V_{DC}$
Gate-Emitter Voltage	V <sub>GE</sub>	15	$V_{DC}$
Collector Current–Continuous @ T <sub>C</sub> = 25°C – Pulsed	I <sub>C</sub>	12 30	A <sub>DC</sub> A <sub>AC</sub>
ESD (Human Body Model) R = 1500 $\Omega$ , C = 100 pF	ESD	8.0	kV
ESD (Machine Model) R = 0 Ω, C = 200 pF	ESD	800	V
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	94 0.63	Watts W/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	ô

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

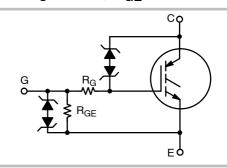


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12 AMPS 410 VOLTS

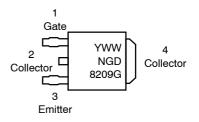
 $V_{CE(on)} \le 2.0 \text{ V } @$   $I_C = 6.0 \text{ A}, V_{GE} \ge 4.0 \text{ V}$ 





DPAK CASE 369C STYLE 7

### **MARKING DIAGRAM**



Y = Year WW = Work Week G = Pb-Free Device

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NGD8209NT4G	DPAK (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Single Pulse Collector-to-Emitter Avalanche Energy	E <sub>AS</sub>		mJ
$V_{CC} = 50 \text{ V}, V_{GE} = 5.0 \text{ V}, \text{ Pk I}_{L} = 7.4 \text{ A}, L = 10 \text{ mH}, \text{ Starting T}_{J} = 25^{\circ}\text{C}$		274	

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.6	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ heta JA}$	105	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	$T_L$	275	°C

<sup>1.</sup> When surface mounted to an FR4 board using the minimum recommended pad size.

## **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	<b>Test Conditions</b>	Temperature	Min	Тур	Max	Unit
OFF CHARACTERISTICS							•
Collector-Emitter Clamp Voltage	BV <sub>CES</sub>	I <sub>C</sub> = 2.0 mA	T <sub>J</sub> = -40°C to 150°C	380	410	435	V <sub>DC</sub>
		I <sub>C</sub> = 10 mA	T <sub>J</sub> = -40°C to 150°C	390	420	445	
Zero Gate Voltage Collector Current	I <sub>CES</sub>		T <sub>J</sub> = 25°C	-	1.0	25	μA <sub>DC</sub>
		$V_{CE} = 350 \text{ V},$ $V_{GE} = 0 \text{ V}$	T <sub>J</sub> = 150°C	-	9.0	50	
		-GE	$T_J = -40^{\circ}C$	-	0.5	15	
Reverse Collector-Emitter Leakage Current	I <sub>ECS</sub>	V <sub>CE</sub> = -24 V	T <sub>J</sub> = 25°C	-	0.5	1.0	mA
			T <sub>J</sub> = 150°C	-	10	30	
			$T_J = -40^{\circ}C$	-	0.05	0.5	
Reverse Collector-Emitter Clamp Voltage	B <sub>VCES(R)</sub>	I <sub>C</sub> = -75 mA	T <sub>J</sub> = 25°C	26	33	38	$V_{DC}$
			T <sub>J</sub> = 150°C	29	36	41	
			$T_J = -40^{\circ}C$	24	32	36	
Gate-Emitter Clamp Voltage	BV <sub>GES</sub>	$I_G = 5.0 \text{ mA}$	T <sub>J</sub> = -40°C to 150°C	10	13	16	V <sub>DC</sub>
Gate-Emitter Leakage Current	I <sub>GES</sub>	V <sub>GE</sub> = 10 V	T <sub>J</sub> = -40°C to 150°C	380	635	1000	μA <sub>DC</sub>
Gate Resistor	$R_{G}$	-	T <sub>J</sub> = -40°C to 150°C	-	70	-	Ω
Gate Emitter Resistor	R <sub>GE</sub>	-	T <sub>J</sub> = -40°C to 150°C	10	16	26	kΩ
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V <sub>GE(th)</sub>	I <sub>C</sub> = 1.0 mA, V <sub>GE</sub> = V <sub>CE</sub>	T <sub>J</sub> = 25°C	1.0	1.42	2.0	$V_{DC}$
			T <sub>J</sub> = 150°C	0.7	0.95	1.5	
		-GE -GE	T <sub>J</sub> = -40°C	1.1	1.62	2.2	
Threshold Temperature Coefficient (Negative)	-	-	-	_	3.5	-	mV/°C

<sup>2.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ S, Duty Cycle  $\leq$  2%.

## **ELECTRICAL CHARACTERISTICS (continued)**

Characteristic	Symbol	Test Conditions	Temperature	Min	Тур	Max	Unit
ON CHARACTERISTICS (continued) (Note 3)							
Collector-to-Emitter On-Voltage	V <sub>CE(on)</sub>		T <sub>J</sub> = 25°C	0.8	1.45	2.0	$V_{DC}$
		I <sub>C</sub> = 6.0 A, V <sub>GE</sub> = 4.0 V	T <sub>J</sub> = 150°C	0.85	1.44	1.85	
	JGE	T <sub>J</sub> = -40°C	1.0	1.5	1.95		
				1.1	1.79	2.3	
		I <sub>C</sub> = 10 A, V <sub>GE</sub> = 4.5 V	T <sub>J</sub> = 150°C	1.2	1.9	2.2	
		· GL	$T_J = -40^{\circ}C$	1.3	1.77	2.2	
Forward Transconductance	gfs	V <sub>CE</sub> = 5.0 V, I <sub>C</sub> = 6.0 A	T <sub>J</sub> = -40°C to 150°C	5.0	14	30	Mhos

<sup>3.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ S, Duty Cycle  $\leq$  2%.

## **TYPICAL CHARACTERISTICS**

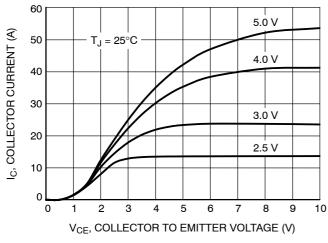


Figure 1. Output Characteristics

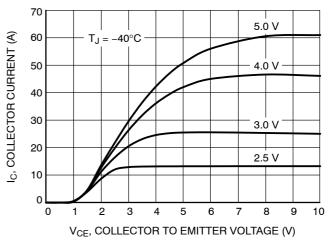


Figure 2. Output Characteristics

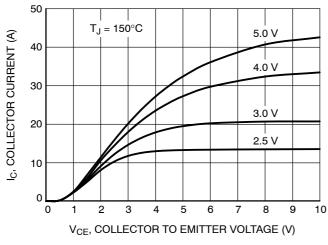


Figure 3. Output Characteristics

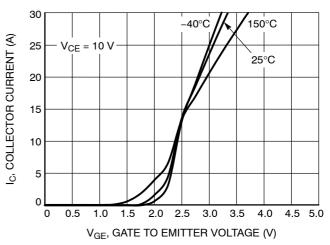
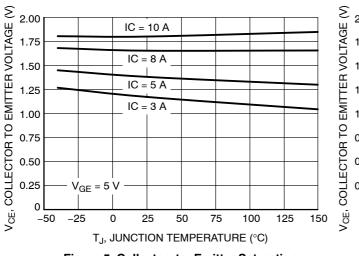


Figure 4. Transfer Characteristics

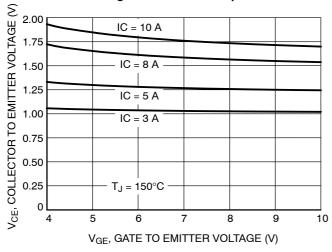
### **TYPICAL CHARACTERISTICS**



2.00 IC = 10 A 1.75 IC = 8 A 1.50 IC = 5 A 1.25 IC = 3 A1.00 0.75 0.50 0.25  $T_J = 25^{\circ}C$ 0 4 6 7 8 9 10 V<sub>GE</sub>, GATE TO EMITTER VOLTAGE (V)

Figure 5. Collector-to-Emitter Saturation Voltage vs. Junction Temperature

Figure 6. Collector-to-Emitter Voltage vs.
Gate-to-Emitter Voltage



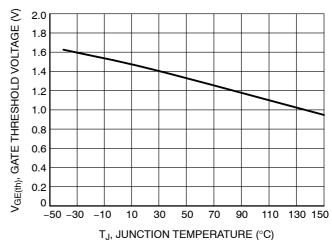


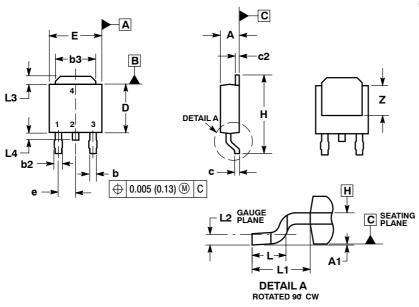
Figure 7. Collector-to-Emitter Voltage vs.
Gate-to-Emitter Voltage

Figure 8. Gate Threshold Voltage vs. Junction Temperature

#### PACKAGE DIMENSIONS

## **DPAK (SINGLE GAUGE)**

CASE 369C ISSUE D



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: INCHES.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DI-MENSIONS b3, L3 and Z.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD
- FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
  DIMENSIONS D AND E ARE DETERMINED AT THE
- OUTERMOST EXTREMES OF THE PLASTIC BODY. 6. DATUMS A AND B ARE DETERMINED AT DATUM
- PLANE H.

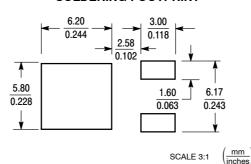
	INC	HES	MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.086	0.094	2.18	2.38		
A1	0.000	0.005	0.00	0.13		
b	0.025	0.035	0.63	0.89		
b2	0.030	0.045	0.76	1.14		
b3	0.180	0.215	4.57	5.46		
С	0.018	0.024	0.46	0.61		
c2	0.018	0.024	0.46	0.61		
D	0.235	0.245	5.97	6.22		
E	0.250	0.265	6.35	6.73		
е	0.090	BSC	2.29	2.29 BSC		
Н	0.370	0.410	9.40	10.41		
L	0.055	0.070	1.40	1.78		
L1	0.108	REF	2.74 REF			
L2	0.020	BSC	0.51	BSC		
L3	0.035	0.050	0.89	1.27		
L4		0.040		1.01		
Z	0.155		3.93			

STYLE 7:

PIN 1. GATE 2. COLLECTOR 3. EMITTER

COLLECTOR

### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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